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U. (Balu) Balachandran

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Editors

U. (Balu) Balachandran

Argonne National Laboratory
9700 S. Cass Avenue, Building #212
Argonne, IL 60439
USA
Email: balu@anl.gov

Kathleen Amm

MRI Technologies & Systems
GE Global Research
One Research Circle, MR118
Niskayuna, NY 12309
USA
Email: ammk@ge.com

Lance Cooley

Fermi National Accelerator Laboratory
PO Box 500, MS 316
Batavia, IL 60510
USA
Email: lcooley@fnal.gov

K. Ted Hartwig

Texas A&M University
319 Mechanical Engineering Office Bldg.
College Station, TX 77843-3123
USA
Email: thartwig@tamu.edu

Michael Osofsky

Naval Research Laboratory
4555 Overlook Avenue SW
Washington, DC 20375
USA
Email: michael.osofsky@nrl.navy.mil

Sastry Pamidi

Florida State University
Center for Advanced Power Systems
2000 Levy Avenue, Bldg A, Ste 140
Tallahassee, FL 32310
USA
Email: pamidi@caps.fsu.edu

Richard Reed

Cryogenic Materials, Inc.
2625 Iliff
Boulder, CO 80305
USA
Email: rpreed@comcast.net

Wolfgang Stautner

GE Global Research
One Research Circle
Niskayuna, NY 12309
USA
Email: Stautner@research.ge.com

Michael Sumption

The Ohio State University
Materials Science Department
CSMM, 477 Watts Hall
2041 College Road
Columbus, OH 43210
USA
Email: Sumption.3@osu.edu

Osamu Umezawa

Yokohama National University
Faculty of Engineering
79-5 Tokiwadai
Hodogaya, Yokohama Kanagawa
240-8501, Japan
Email: umezawa@ynu.ac.jp

Robert Walsh

NHMFL/FSU
1800 E. Paul Dirac Dr.
Tallahassee, FL 32310-3706
USA
Email: walsh@magnet.fsu.edu

Harald Weber

TU Wien - Atominstitut
Stadionallee 2
Vienna University of Technology
Wien, 1020
Austria
Email: weber@ati.ac.at

Managing Editor Staff

Annett D'Antonio and Rose Wickwire
Centennial Conferences
917 Front Street, Suite 220
Louisville, CO 80027
USA
Email: pubs-cecimc@centennialconferences.com

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